



DEV-KIT-SMARC

SMARC 2.0 / 2.1.1 Development Kit

Cross Platform Philosophy Development Kit for SMARC Rel. 2.0 / 2.1.1 compliant modules



STARTER KIT CONTENTS

The Development Kit contains the following material:

- Carrier board for SMARC rel. 2.0 / 2.1.1 compliant modules RB79
- Serial Adapter Cables
- 1x SATA power cable
- Main power Adapter cable
- 1x certified High Speed DP cable, DP1.4 standard compliant
- 1x certified High Speed HDMI cable, HDMI 2.0 compliant
- DP-to-HDMI adapter
- 1x eDP cable

Module not included. Must be purchased separately.



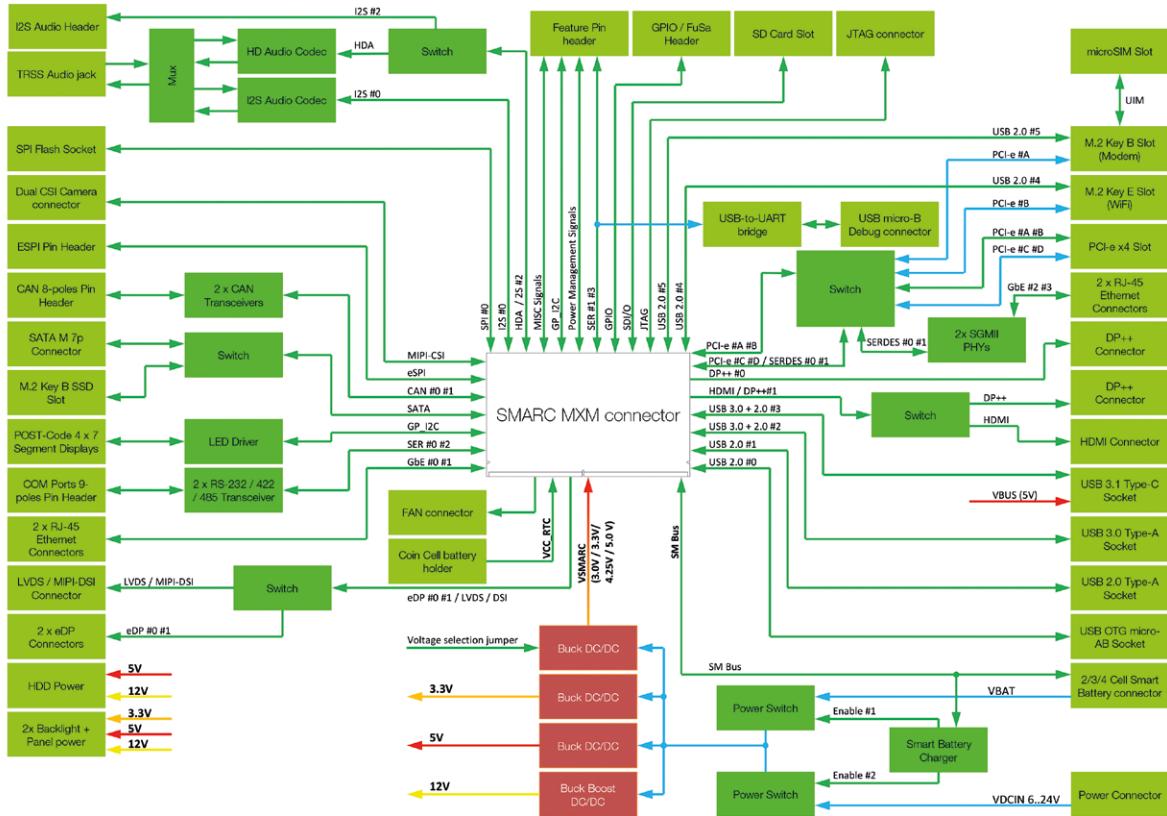
SCHEMATICS PUBLICLY AVAILABLE



FEATURES OF CSM-B79

Video Interfaces	LVDS/MIPI-DSI connector, interface shared with 2x eDP connectors Backlight control + LCD selectable voltages dedicated connector 2xDP++ connectors HDMI connector (can be used in alternative to 1xDP++) 2x CSI Camera input interfaces	Other Interfaces	eSPI pin header + Flash Socket SPI pin header + Flash Socket I2C EEPROM Socket 4 x 7-segment LCD displays for POST codes Feature pin header with 2 x Serial ports, I2C, SM Bus, Watchdog and Power Management Signals GPIO / FuSa pin header FAN connector Optional Debug USB port on micro-B connector Boot selection switches JTAG connector Selector for SMARC 2.0 / 2.1 pinout compatibility
Mass Storage	SATA M 7p connector with dedicated power connector, interface shared with M.2 Socket 2 2230 / 2242 / 2260 Key B SSD slot microSD Card Slot	Power Supply	9-24V through dedicated Mini-Fit Jr 2x2 power connector 6-17V through 2/3/4 Cell Smart Battery Connector RTC Coin cell battery holder
Networking	Up to 2xDual RJ-45 Gigabit Ethernet connectors M.2 Socket1 2230 Key E Slot for WiFi/BT Modules (interface shared with PCI-e x 4 slot) M.2 Socket2 2260 / 3042 Key B Slot for WWAN Modem Modules (interface shared with PCI-e x 4 slot), connected to on-board microSIM slot	Operating Temperature*	-40°C ÷ +85°C
USB Ports	1 x USB 3.0 type A Socket 1 x USB 2.0 type A Socket 1 x USB OTG micro-AB Socket 1 x USB 3.1 Type-C Socket	Dimensions	243.84 x 243.84mm (microATX)
PCI-e	PCI-e x4 slot, interface shared with M.2 Slots	*All carrier board components must remain within the operating temperature at any and all times, including start-up; carrier operating temperature is independent of the module installed. Please refer to the specific module for more details. Actual temperature will widely depend on application, enclosure and/or environment. Upon customer to consider specific cooling solutions for the final system.	
Audio	TRSS Mic In + Line Out Audio Jack Onboard I2S Audio Codec (TI TLV320AIC3204) + HD Audio Codec (Cirrus Logic CS4207) I2S Audio header		
Serial Ports	2 x CAN ports 2 x RS-232/RS-422/RS-485 configurable serial ports on internal pin header 2 x Serial ports (Tx/Rx signals only, TTL level) on feature pin header		

BLOCK DIAGRAM



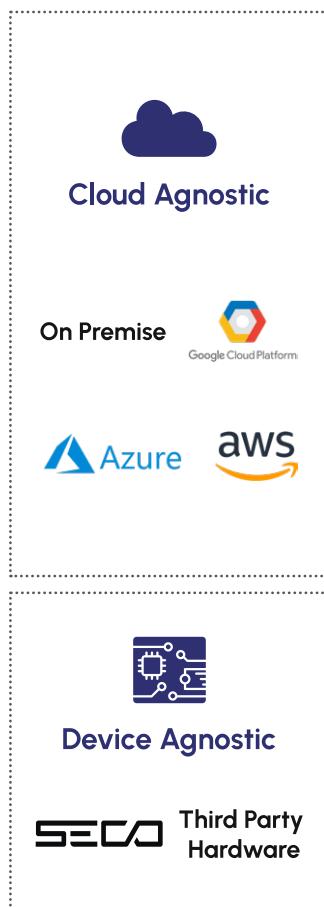
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Update, configure, and manage remote devices. Optimize time and costs to maximize operational efficiency and security without the need for costly field interventions.

PORTAL

Analyze data from remote devices, customize the user experience with applications tailored to user needs, and manage user rights, company access, and tenant privileges.

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Device Manager

»Edgehog

Data Orchestration

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